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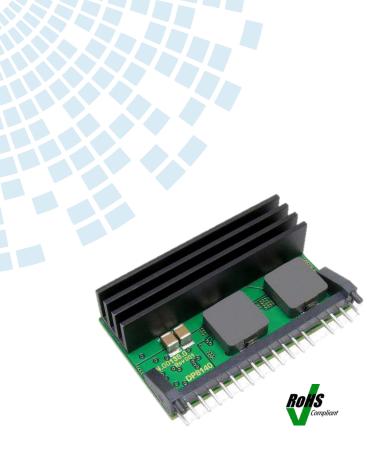
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Key Features & Benefits

- Input voltage range: 8 –14 V
- Programmable key features
- A voltage out range of 0.7–3.65 V at 0 to 40 A
- Efficiency greater than 93% with a built in heat sink.
- Two phase 500 KHz switching for low ripple noise.
- Flexible Fault Response features
- Multiple turn-on/off slew rates and delays
- Digital Filter Compensation
- Synchronous operation with other supplies
- Real time performance monitoring
- GUI based configuration for short development time.
- Low height of 1.1" suitable for 1U high enclosures
- Approved to the latest edition and amendment of ITE Safety standards, UL/CSA 60950-1 and IEC60950-1

DP8140G 40A DC-DC Intelligent dPOL

Bel Power Solutions **DP8140G** is an intelligent, fully programmable step-down point-of-load DC-DC converter integrating digital power conversion and intelligent power management.

The dPOL is used in conjunction with DM73xx Series Digital Power Manager (DPM), and completely eliminates the need for external components for output voltage setting, sequencing, tracking, protection, monitoring, error amplifier compensation and reporting.

All performance parameters of the DP8140G are programmable and managed through Digital Power Manager via the industry-standard I²C communication bus and can be changed by a user at any time during product development and operation.

Telemetry data is available in real time and can be accessed over the I²C bus.

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1. ORDERING INFORMATION

DP	81	40	G	-	zz
Product Family	Series	Output Current	RoHS Compliance	Dash	Packaging Option ¹
d-pwer®	Intelligent dPOL Converter	40 A	G - RoHS compliant for all six substances		T050 - 50pc Tray Sample quantity orders have no suffix.

Example:

DP8140G-T050: A 50-piece tray of RoHS compliant dPOL converters. Each dPOL converter is labelled DP8140G.

Reference Documents

- DM7300 Digital Power Manager Data Sheet
- DM7300 Digital Power Manager Programming Manual
- I2C Graphical User Interface
- DM00056-KIT USB to I²C Adapter Kit. User Manual

2. ABSOLUTE MAXIMUM RATINGS

Stresses in excess of the absolute maximum ratings may cause performance degradation, adversely affect long-term reliability and cause permanent damage to the converter.

PARAMETER	CONDITIONS / DESCRIPTION	MIN	MAX	UNITS
Inductor Temperature	Input Voltage applied	-40	125	°C
Input Voltage	250 ms Transient		15	VDC
Output Current	(See Output Current De-rating Curves)	-16	20	ADC

3. ELECTRICAL SPECIFICATIONS

Specifications apply at the input voltage from 8 V to 14 V, output load from 0 to 20 A, ambient temperature from - 40°C to 85°C. Test conditions include an output filter with 3 x 330 μ F 20 m Ω solid electrolytic, plus 2 x 22 μ F X7R ceramic output capacitors, unless otherwise noted.

3.1. INPUT SPECIFICATIONS

PARAMETER	CONDITIONS / DESCRIPTION	MIN	NOM	MAX	UNITS
Input Voltage (V _{IN})		8		14	VDC
Input Current (at no load)	$V_{IN} = 14.0 \text{ V}, V_{OUT} = 3.3 \text{ V}$		50		mADC
Undervoltage Lockout	Ramping Up	5		7.5	VDC
Ondervoltage Lockout	Ramping Down	3			VDC
VLDO Input Current	Current drawn from the external low voltage supply at VLDO = 8 V		50		mADC

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¹ Packaging option is used only for ordering and not included in the part number printed on the dPOL converter label.

3.2. OUTPUT SPECIFICATIONS

PARAMETER	CONDITIONS / DESCRIPTION	MIN	NOM	MAX	UNITS
Output Voltage Range (Vout)		0.7		3.65	VDC
Output Voltage Setpoint Resolution			2.5 mV (1	LSB)	
Output Voltage Setpoint Accuracy	2 nd Vo Loop Enabled		±(0.6% +	5 mV)	
Output Current (I _{OUT})	V _{IN MIN} to V _{IN MAX}	-32 ²		40	ADC
Line Regulation	V _{IN MIN} to V _{IN MAX}		±0.3		$%V_{\text{OUT}}$
Load Regulation	0 to lout MAX		±0.2		$%V_{\text{OUT}}$
Dynamic Regulation Peak Deviation Settling Time	Slew rate 1A/ μ s, 50 -75% load step F_{SW} = 500 kHz to 10% of peak deviation		50		mV
Octuing Time	See Output Load Transient Section		60		μS
	$V_{IN} = 8.0 \text{ V}, V_{OUT} = 0.7 \text{ V}$		10		mV
Output Voltage Peak-to-Peak	$V_{IN} = 8.0 \text{ V}, V_{OUT} = 2.5 \text{ V}$		20		mV
Ripple and Noise	$V_{IN} = 8.0 \text{ V}, V_{OUT} = 3.65 \text{ V}$		40		mV
Scope BW = 20 MHz Full Load	$V_{IN} = 14 \text{ V}, V_{OUT} = 0.7 \text{ V}$		18		mV
ruii Loau	$V_{IN} = 14 \text{ V}, V_{OUT} = 2.5 \text{ V}$		35		mV
	$V_{IN} = 14 \text{ V}, V_{OUT} = 3.65 \text{ V}$		50		mV
Temperature Coefficient	$V_{IN} = 12 \text{ V}, I_{OUT} = 0.5 \times I_{OUT \text{ MAX}}$		20		ppm/°C
0 " 1 " 5	Default		500		kHz
Switching Frequency	Programmable to		500/1000		kHz
D. C. de Livii	Default		90.5		%
Duty Cycle Limit	Programmable, 1.56% steps	3.125		100	%

3.3. PROTECTION SPECIFICATIONS

PARAMETER	CONDITIONS / DESCRIPTION	MIN	NOM	MAX	UNITS		
Output Overcurrent Protect	tion						
Tuno	Default	Non-Late	ching, 130 ms	s period			
Туре	Programmable	Latch	Latching/Non-Latching				
Throphold	Default		132		%IOUT		
Threshold	Programmable in 11 steps	36		132	%юит		
Threshold Accuracy		-20		+20	%I _{OCP.SET}		
Output Overvoltage Protection							
Tuno	Default Non-Latching, 130 ms period						
Туре	Programmable	Latching/Non-Latching					
Threshold	Default		130		$\%V_{\text{O.SET}}$		
Tiresnoid	Programmable in 10% steps	110		130	$\%V_{\text{O.SET}}$		
Threshold Accuracy	Measured at Vo.set=2.5V	-2		2	$\%V_{\text{OVP.SET}}$		
Delay	From instant when threshold is exceeded until the turn-off command is generated		6		μS		
Turn Off Behavior ³	Default	Е	mergency Of	f			
Turri Ori Deriavior	Programmable to	Critical	Critical Off / Emergency Off				

² At negative (sink) output current (bus terminator mode) the efficiency of the DP8140G degrades resulting in increased internal power dissipation and switching noise. Therefore maximum allowable negative current under specific conditions is lower than the current determined from the de-rating curves shown in paragraph.

3 Sequenced Off: The turn-off follows the turn-off delay and slew-rate settings; Critical Off: At turn-off both low and high switches

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are immediately disabled; Catastrophic Off: At turn-off the high side switch is disabled and the low side switch is enabled.

Output Undervoltage Prote	ection				
Tumo	Default	Non-Late	hing, 130 m	s period	
Type	Programmable	Latchi	ng/Non-Late	ching	
Threshold	Default		75		%Vo.set
mresnoid	Programmable in 5% steps	75		90	%Vo.se
Threshold Accuracy	Measured at V _{O.SET} = 2.5 V	-2		2	%V _{UVP.SE}
Delay	From instant when threshold is exceeded until the turn-off command is generated		6		μS
Turn Off Behavior ³	Default	Se	equenced Of	ff	
Taill on Bollaviol	Programmable to	Seque	nced / Critic	al Off	
Overtemperature Protection	on				
Type	Default	Non-Late	hing, 130 m	s period	
Турс	Programmable	Latchi	ng/Non-Late	ching	
Turn Off Threshold	Temperature is increasing		120		°C
Turn On Threshold	Temperature is decreasing after the module was shut down by OTP ⁴		110		°C
Threshold Accuracy		-5		5	°C
Delay	From instant when threshold is exceeded until the turn-off command is generated		6		μS
Turn Off Behavior ³	Default	Sequenced Off			
	Programmable to	Seque	nced / Critic	al Off	
Tracking Protection (when					
Type	Default	Disabled			
••	Programmable	Latching/N	lon-Latching	g, 130 ms	
Threshold	Enabled during output voltage ramping up			±250	mVDC
Threshold Accuracy		-50		50	mVDC
Delay	From instant when threshold is exceeded until the turn-off command is generated		6		μS
Overtemperature Warning					_
Threshold	Always enabled, reported in Status register (TW bit) ⁵	_	110	_	°C
Threshold Accuracy	From Nominal Set Point	-5		+5	°C
Hysteresis			1.7		°C
Power Good Signal (PG pi					
Logic	V _{OUT} is inside the PG window		High		
-3 -	V _{OUT} is outside the PG window		Low		
Lower Threshold	Default		90		%Vo.set
	Programmable in 5% steps	90		95	%Vo.set
Upper Threshold	Default		110		%Vo.set
оррог типосиона	Programmable in 5% steps	105		110	%Vo.set
Threshold Accuracy	Measured at V _{O.SET} = 2.5 V	-2		2	%Vo.set
PG On Delay ⁶	Default		0		ms
. G S. Dolay	Programmable at		, 10, 50, 150		ms
PG Off Delay	Default		oled when Vo threshold sabled at tur		
	Programmable same as PG On Delay		nd (Reset fu		





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OTP clears when Overtemp Warning (Status Register TW bit) turns off.
 Temp Warning error same sign and proportional with OTP error.
 From instant when threshold is exceeded until status of PG signal changes high

3.4. FEATURE SPECIFICATIONS

PARAMETER	CONDITIONS / DESCRIPTION	MIN	NOM	MAX	UNITS
Current Share					
Type			Active, S	ingle Line	
Maximum Number of Modules Connected in Parallel	I _{OUT} ≥ 20%×I _{OUT NOM}		•	4	
Current Share Accuracy	I _{OUT} ≥ 20%×I _{OUT NOM}			±20	%l _{out}
Interleave					
Interleave (Phase Shift)	Default		0		Degree
oouvo (r. naes eny	Programmable in 22.5° steps	0		337.5	Degree
Sequencing 7					
Turn ON Delay	Default		0		ms
ram on Bolay	Programmable in 1ms steps	0		255	ms
Turn OFF Delay	Default		0		ms
ram or r zolay	Programmable in 1ms steps	0		63	ms
Tracking					
Turn ON Slew Rate	Default		0.05		V/ms
Turn on olew hate	Programmable in 8 steps	0.05		2.0 8	V/ms
Turn OFF Slew Rate	Default		-0.05		V/ms
Turr of Folew Flate	Programmable in 8 steps	-0.05		-2.0 ⁸	V/ms
Optimal Voltage Positioning					
Load Regulation	Default		0		mV/A
Load Negulation	Programmable in 7 steps	0		2.45	mV/A
Feedback Loop Compensation					
Proportional (Kr)	Programmable	0.01		2	
Integral (Ti)	Programmable	1		100	μs
Differential (Td)	Programmable	1		100	μs
Differential Roll-Off (Tv)	Programmable	1		100	μs
Monitoring					
Voltage Monitoring Accuracy	12 Bit Resolution over 0.55.5 V	-0.5		0.5	%
Current Monitoring Accuracy	20% I _{OUT NOM} < I _{OUT} < I _{OUT NOM}	-20		+20	%I _{OUT}
Temperature Monitoring Accuracy	Junction temperature of dPOL controller	-5		+5	°C
Remote Voltage Sense (+VS and -V	'S pins) ⁹				
Voltage Drop Compensation	Between +VS and VOUT			300	mV
Voltage Drop Compensation	Between -VS and PGND			100	mV

⁹ For remote sense, it is recommended to place a 0.01-0.1μF ceramic capacitor between +VS and -VS pins as close to the dPOL converter as possible.





 $^{^{\}rm 7}~$ Timing based on SD clock and subject to tolerances of SD.

⁸ Achieving fast slew rates under specific line and load conditions may require feedback loop adjustment. See Rising and Falling Slew Rates

3.5. SIGNAL SPECIFICATIONS

PARAMETER	CONDITIONS / DESCRIPTION	MIN	NOM	MAX	UNITS
VDD	Internal supply voltage	3.15	3.3	3.45	V
Logic In Max	Pull Up Logic max safe input			VDD+.5	V
SYNC/DATA Line (SD pin)					
ViL_sd	LOW level input voltage	-0.5		0.3 x VDD	V
ViH_sd	HIGH level input voltage	0.75 x VDD		VDD + 0.5	V
Vhyst_sd	Hysteresis of input Schmitt trigger	0.25 x VDD		0.45 x VDD	V
VoL	LOW level sink current @ 0.5V	14		60	mA
Tr_sd	Maximum allowed rise time 10/90%VDD			300	ns
Cnode_sd	Added node capacitance		5	10	pF
lpu_sd	Pull-up current source at Vsd=0V	0.3		1.0	mA
Freq_sd	Clock frequency of external SD line	475		525	kHz
Tsynq	Sync pulse duration	22		28	% of clock cycle
ТО	Data=0 pulse duration	72		78	% of clock cycle
Inputs: ADDR0ADDR4, E	EN, IM				
ViL_x	LOW level input voltage	-0.5		0.3 x VDD	V
ViH_x	HIGH level input voltage	0.7 x VDD		VDD+0.5	V
Vhyst_x	Hysteresis of input Schmitt trigger	0.1 x VDD		0.3 x VDD	
RdnL_ADDR	External pull down resistance ADDRX forced low			10	kOhm
Power Good and OK Input	ts/Outputs				
lup_PG	Pull-up current source input forced low PG	25		110	μΑ
lup_OK	Pull-up current source input forced low OK	175		725	μΑ
ViL_x	LOW level input voltage	-0.5		0.3 x VDD	V
ViH_x	HIGH level input voltage	0.7 x VDD		VDD+0.5	V
Vhyst_x	Hysteresis of input Schmitt trigger	0.1 x VDD		0.3 x VDD	V
loL	LOW level sink current at 0.5V	4		20	mA
Current Share Bus (CS pire	l)				
lup_CS	Pull-up current source at VCS = 0V	0.84		3.1	mA
ViL_CS	LOW level input voltage	-0.5		0.3 x VDD	V
ViH_CS	HIGH level input voltage	0.75 x VDD		VDD+0.5	V
Vhyst_CS	Hysteresis of input Schmitt trigger	0.25 x VDD		0.45 x VDD	V
loL	LOW level sink current at 0.5V	14		60	mA
Tr_CS	Maximum allowed rise time 10/90% VDD			100	ns



4. PIN ASSIGNMENTS AND DESCRIPTIONS

PIN NAME	PIN NUMBER	PIN TYPE	BUFFER TYPE	PIN DESCRIPTION	NOTES
ОК	6	I/O	PU	Fault/Status Condition	Connect to OK pin DPM and other dPOLs in the same Group, if any.
SD	4	I/O	PU	Sync/Data Line	Connect to SD pin of DPM
PG	11	I/O	PU	Power Good	Pin state reflected in Status Register.
CS	3	I/O	PU	Current Share	Connect to CS pin of other dPOLs connected in parallel
ADDR4	5	1	PU	dPOL Address Bit 4	Tie to GND for 0 or leave floating for 1
ADDR3	10	1	PU	dPOL Address Bit 3	Tie to GND for 0 or leave floating for 1
ADDR2	9	1	PU	dPOL Address Bit 2	Tie to GND for 0 or leave floating for 1
ADDR1	8	1	PU	dPOL Address Bit 1	Tie to GND for 0 or leave floating for 1
ADDR0	7	1	PU	dPOL Address Bit 0	Tie to GND for 0 or leave floating for 1
-VS	18	1	Α	Negative Voltage Sense	Connect to the negative point close to the load or VOUT
+VS	15	1	Α	Positive Voltage Sense	Connect to the positive point close to the load or PGND
VOUT	12, 13	Р		Output Voltage	
GND	2, 16, 17	Р		Power Ground	
VIN	1	Р		Input Voltage	

Legend: I=input, O=output, I/O=input/output, P=power, A=analog, PU=internal pull-up, NC=No Connection

5. TYPICAL PERFORMANCE CHARACTERISTICS

5.1. DISSIPATION AND EFFICIENCY CURVES

Figure 1. Available output current vs. ambient air temperature and airflow rates for converter DP8140G mounted horizontally with air flowing from input to output, Vin = 12 V, Vout = 3.3 V, and Fsw = 500 KHz

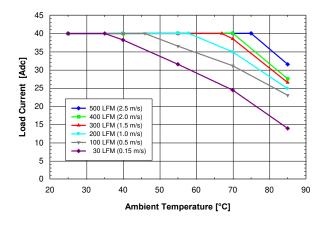
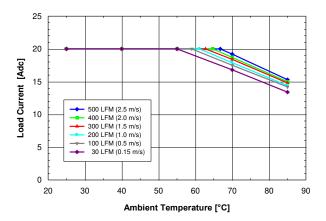


Figure 2. Available output current vs. ambient air temperature and airflow rates for converter DP8140G mounted horizontally with air flowing from input to output, MOSFET temperature ≤ 120°C, Vin = 12 V, Vout = 5 V, and Fsw = 500 KHz





5.2. EFFICIENCY CURVES

Figure 1. Efficiency vs. Load. Vin=12V, Fsw=500kHz

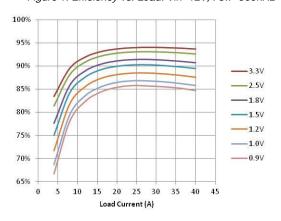


Figure 3. Efficiency vs Load, Vin=8V, Fsw=500KHz

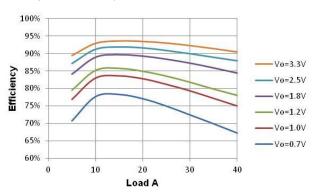


Figure 5. Efficiency vs Vout, Load=40A, Fsw=500KHz

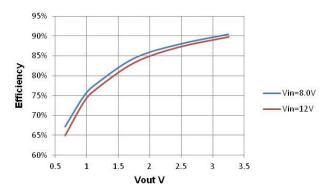


Figure 2. Dissipation vs Load, Vin=12v, Fsw=500KHz

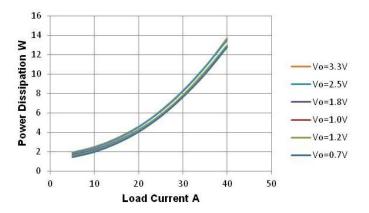


Figure 4. Dissipation vs Load, Vin=8V, Fsw=500KHz

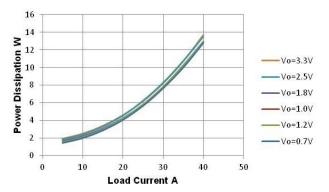
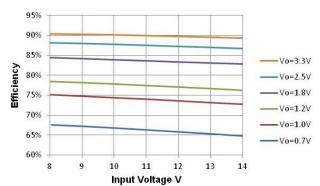


Figure 6. Efficiency vs Vin, Load=40A, Fsw=500KHz





6. PROGRAMMABLE FEATURES

Performance parameters of DP8140G dPOL converters are programmed by the system DPM over a self-clocking single wire bus as need. Each parameter is stored in FLASH memory in the DPM and loaded into volatile memory registers in the dPOL control chip detailed in Table 1. Setup registers 00h through 14h are programmed at the system power-up. When the input voltage is removed, the dPOL controller's default values are restored.

Table 1. DP8140G Memory Registers

CONFIGUR	RATION REGISTERS	
Name	Register	Address
PC1 PC2 PC3 TC INT DON DOF VLC CLS DCL PC4 V1H V1L	Protection Configuration 1 Protection Configuration 2 Protection Configuration 3 Tracking Configuration Interleave and Frequency Configuration Turn-On Delay Turn-Off Delay Voltage Loop Configuration Current Limit Set-point Duty Cycle Limit Protection Configuration 4 Output Voltage Setpoint 1 (Low Byte) Output Voltage Setpoint 1 (High Byte)	0x00 0x01 0x02 0x03 0x04 0x05 0x06 0x07 0x08 0x09 0x0A 0x0B
V2H V2L V3H V3L CP CI CD B1	Output Voltage Setpoint 7 (Ingli Byte) Output Voltage Setpoint 2 (Low Byte) Output Voltage Setpoint 3 (Low Byte) Output Voltage Setpoint 3 (High Byte) Output Voltage Setpoint 3 (High Byte) Controller Proportional Coefficient Controller Integral Coefficient Controller Derivative Coefficient Controller Derivative Roll-Off Coefficient	0x0D 0x0E 0x0F 0x10 0x11 0x12 0x13 0x14
STATUS R	EGISTERS	
Name	Register	Address
RUN ST	Run enable / status Status	0x15 0x16
	ING REGISTERS	
Name	Register	Address
VOH VOL IO TMP	Output Voltage High Byte (Monitoring) Output Voltage Low Byte (Monitoring) Output Current (Monitoring) Temperature (Monitoring)	0x17 0x27 0x18 0x19

DP8140G converters can be programmed using the Graphical User Interface or directly via the I²C bus by using high and low level commands as described in the "DPM Programming Manual".

DP8140G parameters can be reprogrammed at any time during the system operation and service except for the digital filter coefficients, the switching frequency and the duty cycle limit, that can only be changed when the dPOL output is turned off.

6.1. OUTPUT VOLTAGE

The output voltage can be programmed in the GUI Output Configuration window shown in the Figure 9 or directly via the I²C bus by writing into the VOS register shown in Figure 10.



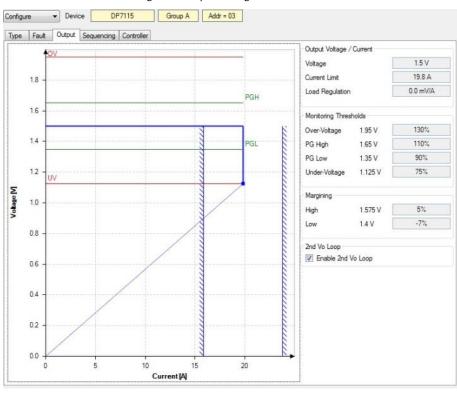


Figure 7. Output Configuration Window

Note that the GUI shows the effect of setting PG, OV and UV limits as both values and graphical limit bars. Vertical hashed lines are error bars for the Overcurrent (OC) limit.

6.1.1. Output Voltage Setpoint

The output voltage programming range is from 0.7 V to 5.5 V. The resolution is constant across the range and is 2.5 mV. A Total of 3 registers are provided: one should be used for the normal setpoint voltage; the other two can be used to define a low/high margining voltage setpoint. Note that each register is 16bit wide and that the high byte needs always to be written / read first. The writing of the low byte triggers the refresh of the whole 16bit register (the high byte is written to a shadow register).

Unlike other configuration registers, the dPOL controller's VOS registers are dynamic. Changes to VOS values can be made while the output is enabled over the I²C bus through register bypass commands and the POL will change its output immediately.

Figure 8. Output Voltage Setpoint Register VOS

VOS: Output Voltage Set-Point Address: 0x0B ... 0x10

	Coefficient	Addr	Bits	Default
V1H	First Vo Setpoint High Byte	0x0B	8	
V1L	First Vo Setpoint Low Byte	0x0C	8	
V2H	Second Vo Setpoint High Byte	0x0D	8	
V2L	Second Vo Setpoint Low Byte	0x0E	8	
V3H	Third Vo Setpoint High Byte	0x0F	8	
V3L	Third Vo Setpoint Low Byte	0x10	8	

Mapping:

- 12 bit data word, left aligned
- 1LSB = 2.5mV

Note:

- all registers are readable and writeable
- always write and read the high byte first



6.1.2. Output Voltage Margining

If the output voltage needs to be varied by a certain percentage, the margining function can be utilized. The margining can be programmed in the dPOL Configuration window or directly via the I²C bus using high level commands as described in the "DM7300 Digital Power Manager Programming Manual".

In order to properly margin dPOLs that are connected in parallel, the dPOLs must be members of one of the Parallel Buses. Refer to the GUI System Configuration Window shown in Figure 49.

6.1.3. Optimal Voltage Positioning

Where output sensing to a specific load is not feasible, load currents will induce an IR voltage drop. Offsetting the output voltage setting can gain some relief at the load from voltage drops from high load currents by setting the output voltage slightly higher, as shown in Figure 11.

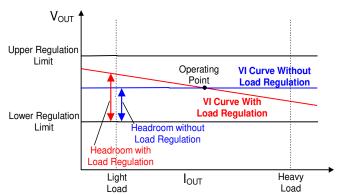


Figure 9. Optimal Voltage Positioning Concept

6.1.4. Output Load Regulation Control

Load Regulation provides for dynamic output voltage change proportional to load current. This feature helps to improve step load response by changing the VI characteristic slope at the point of regulation. This can be programmed in the GUI Output Configuration window shown in Figure 9 or directly via the I²C bus. In the DP8140G Regulation can be set to one of eight values: 0, 0.18, 0.37, 0.55, 0.73, 0.92, 1.1, or 1.29 mv/A.

Figure 12 shows a DP8140G POL with 0 mv/A (load current) regulation. Alternating high and low output load currents causes large transients in Vout to appear with each change.

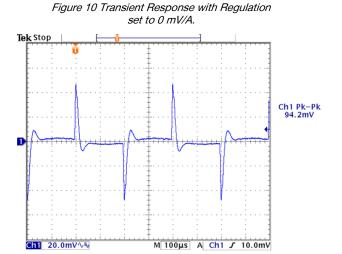
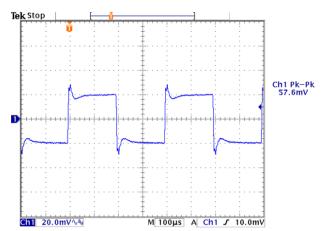


Figure 11 Transient response with non-zero Regulation.





As the Load Regulation parameter is increased, step offsets in output voltage begin to appear, as shown in Figure 13. The Load Regulation parameter is an important part of Current Sharing. It is used to set one dPOL as a "master", by assigning a lower mV/A load regulation than all other dPOLs which share the load as "slaves". The dPOL with the lowest Regulation parameter sets the effective overall regulation. (See Current Sharing elsewhere in this document.)

6.2. SEQUENCING AND TRACKING

Turn-on delay, turn-off delay, and rising and falling output voltage slew rates can be programmed in the dPOL Configure Sequencing window shown in Figure 14 or directly via the I²C bus by writing into the DON, DOF, and TC registers, respectively. The registers are shown in Figure 15, Figure 17, and Figure 18.



Figure 12. dPOL Configure Sequencing Window

6.2.1.Turn-On Delay

Turn-on delay is defined as an interval from the application of the Turn-On command until the output voltage starts ramping up.

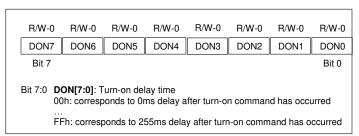


Figure 13. Turn-On Delay Register DON



6.2.2.Turn-Off Delay

Turn-off delay is defined as an interval from the application of the Turn-Off command until the output voltage reaches zero (if the falling slew rate is programmed) or until both high side and low side switches are turned off (if the slew rate is not programmed). Therefore, for the slew rate controlled turn-off the ramp-down time is included in the turn-off delay as shown in Figure 16.

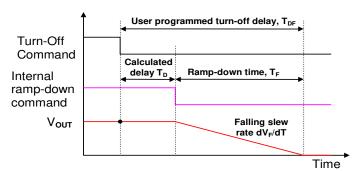


Figure 14. Relationship between Turn-Off Delay and Falling Slew Rate

As it can be seen from Figure 16, the internally calculated delay T_D is determined by the equation below.

$$T_D = T_{DF} - \frac{V_{OUT}}{dV_F/dT},$$

For proper operation T_D shall be greater than zero. The appropriate value of the turn-off delay needs to be programmed to satisfy the condition.

If the falling slew rate control is not utilized, the turn-off delay only determines an interval from the application of the Turn-Off command until both high side and low side switches are turned off. In this case, the output voltage ramp-down process is determined by load parameters.

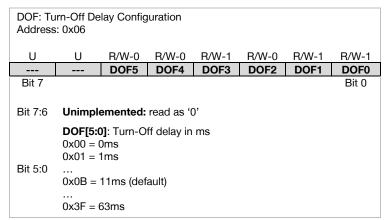


Figure 15. Turn-Off Delay Register DOF



6.3. TURN-ON/OFF CONTROL

Once delays are accounted for, turn-on and turn-off characteristics are simply a function of slew rates, which are selectable.

6.3.1. Rising and Falling Slew Rates

Output voltage ramp up (and down) control is accomplished by programming the rising and falling slew rates of the output voltage, supported in the GUI as shown in Figure 14, which is implemented by the DPM through writing data to the TC register, Figure 18.

To achieve programmed slew rates, the output voltage is being changed in 10mV steps where duration of each step determines the slew rate. For example, ramping up a 1.0V output with a slew rate of 0.5V/ms will require 100 steps duration of 20μs each.

Duration of each voltage step is calculated by dividing the master clock frequency generated by the DPM. Since all dPOLs in the system are synchronized to the master clock, the matching of voltage slew rates of different outputs is very accurate as it can be seen in Figure 19 and Figure 24.

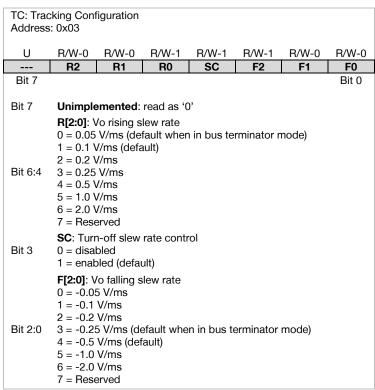


Figure 16. Tracking Configuration Register TC

During the turn on process, a dPOL not only delivers current required by the load (I_{LOAD}), but also charges the load capacitance. The charging current can be determined from the equation below:

$$I_{CHG} = C_{LOAD} \times \frac{dV_R}{dt}$$

Where, C_{LOAD} is load capacitance, dV_{R}/dt is rising voltage slew rate, and I_{CHG} is charging current. When selecting the rising slew rate, a user needs to ensure that

$$I_{LOAD} + I_{CHG} < I_{OCP}$$

Where I_{OCP} is the overcurrent protection threshold of the dPOL. If the condition is not met, then the overcurrent protection will be triggered during the turn-on process. To avoid this, dV_{R}/dt and the overcurrent protection threshold should be programmed to meet the condition above.



6.3.2. Delay and Slew Rate Combination

The effect of setting slew rates and turn on/off delays is illustrated in the following sets of figures.

Figure 17. Tracking Turn-On. Rising Slew Rate is programmed at 0.5V/ms for each output.

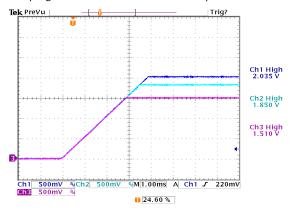


Figure 19. Sequenced Turn-On. Rising Slew Rate is programmed at 1V/ms. V2 Delay is 2ms, V3 delay is 4ms.

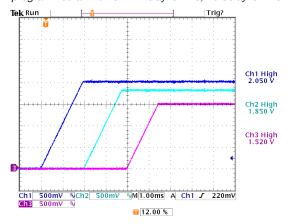


Figure 18. Turn-On with Different Rising Slew Rates. Rising Slew Rates are V1-1V/ms, V2-0.5V/ms, V3-0.2V/ms.

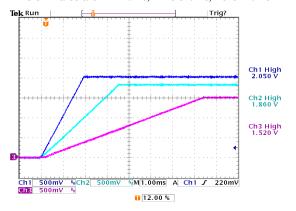
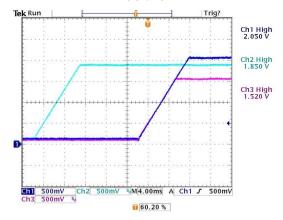


Figure 20 Two outputs delayed 5ms. All slew rates at 0.5V/ms.



6.3.3.Pre-Bias

In some applications, power may "leak" from a powered circuit to an unpowered bus, typically through ESD protection diodes. The d-pwer® controller in the dPOL holds off turn on its output until the desired ramp up point crosses the pre-bias point, as seen in Figure 23.

Figure 21. Turn On into Prebiased Load. V3 is Prebiased by V2 via a Diode.

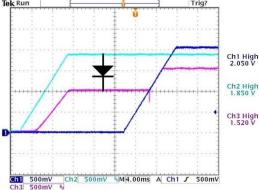




Figure 23 was captured with an actual system where a diode was added to pre-bias a 1.5V bus from a 1.85V bus in order to simulate the effect of current leakage through protection circuits of unpowered logic connected to powered logic outputs (a common source of pre-bias in power systems).

6.4. TURN-OFF CHARACTERISTICS

Turn of captures show that combining turn off delays and ramp rates. Note that while turnoff delays have a lower upper time limit as compared to turn on delays, all ramp down rates are available independently to turn on and off.

Figure 22. Tracking Turn-Off. Falling Slew Rate is programmed at 0.5V/ms.

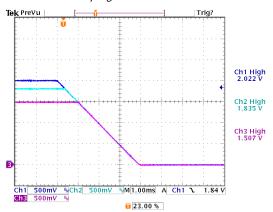
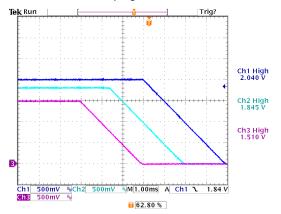


Figure 23. Turn-Off with Tracking and Sequencing. Falling Slew Rate is programmed at 0.5V/ms.



6.5. FAULTS, ERRORS AND WARNINGS

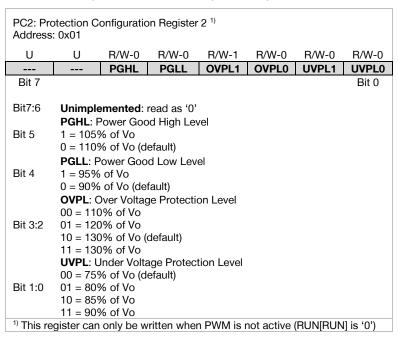
All dPOL series converters have a comprehensive set of programmable fault and error protection functions that can be classified into three groups based on their effect on system operation: warnings, faults, and errors. These are warnings, errors and faults. Warnings include Thermal (Overtemperature limit near) and Power Good (a warning in a negative sense.)

Faults in dP8xxx series POLs include overcurrent protection, overvoltage, overtemperature and tracking failure detection. Errors include only undervoltage. Control of responses to Faults and Errors are distributed between different dPOL registers and are configurable in the GUI.

Thresholds of overcurrent, over- and undervoltage detection, and Power Good limits can be programmed in the GUI Output Configuration window (Figure 9) or directly via the I²C bus by writing into the PC2 registers shown in Fig. 26.



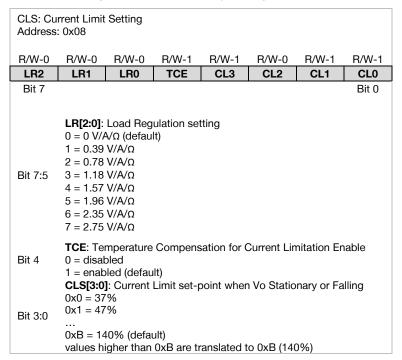
Figure 24. Protection Configuration Register PC2



Note that the overvoltage and undervoltage protection thresholds and Power Good limits are defined as percentages of the output voltage. Therefore, the absolute levels of the thresholds change when the output voltage setpoint is changed either by output voltage adjustment or by margining.

Overcurrent limits are set either in the GUI POL Output configuration dialog or in the POL's CLS register as shown in Figure 27.

Figure 25. Current Limit Setpoint Register CLS





Note that the CLS register includes bits which control the Regulation option settings. When writing into this register be careful to not change Regulation by accident.

6.5.1.Warnings

This group includes Overtemperature Warning and Power Good Signal. Warnings do not turn off dPOLs but rather generate signals that can be transmitted to a host controller via the I²C bus.

6.5.1.1. Overtemperature Warning

The Overtemperature Warning is generated when temperature of the controller exceeds 120°C. The Overtemperature Warning changes the TW bit of the status register ST. When the temperature falls below 117°C, the PT bit is cleared and the Overtemperature Warning is removed.

6.5.1.2. Power Good

Power Good (PG) is an open collector output that is pulled low, if the output voltage is outside of the Power Good window. The window is formed by the Power Good High threshold that is programmable at 105 or 110% of the output voltage and the Power Good Low threshold that can be programmed at 90 or 95% of the output voltage.

Power Good protection is only enabled after the output voltage reaches its steady state level. A programmable delay can be set between 0 and 150ms to delay the release of the PG pin after the voltage has reached the steady state level (see Figure 14). This allows using the PG pin to reset load circuits properly. The Power Good protection remains active during margining voltage transitions. The threshold will vary proportionally to the voltage change (see Figure 28)

The Power Good Warning pulls the PG pin low and changes the PG bit of the status register ST to 0. When the output voltage returns within the Power Good window, the PG pin is released high, the PG bit is cleared and the Power Good Warning is removed. The Power Good pin can also be pulled low by an external circuit to initiate the Power Good Warning.

At turn-off the PG pin can be programmed to either be pulled low immediately following the turn-off command, or then when the voltage actually starts to ramp down (Reset vs. Power Good functionality in Figure 14).

Note:

To retrieve status information, Status Monitoring in the GUI DPM Configure Devices window should be enabled (refer to Digital Power Manager Data Sheet). The DPM will retrieve the status information from each dPOL on a continuous basis.

6.5.2.Faults

This group includes overcurrent, overtemperature, undervoltage, and tracking protections. Triggering any protection in this group will turn off the dPOL. For UV and OT faults the turn-off can be programmed to sequenced or critical turn-off behavior:

6.5.2.1. Overcurrent Protection

Overcurrent protection is active whenever the output voltage of the dPOL exceeds the prebias voltage (if any). When the output current reaches the OC threshold, the POL control chip asserts an OC fault. The dPOL sets the OC bit in the register ST to 0. Both high side and low side switches of the dPOL are turned off instantly (fast turn-off). Current sensing is across the dPOLs choke. To compensate for copper winding T_C , compensation is added to keep the OC threshold approximately constant at temperatures above room temperature. Note that the temperature compensation can be disabled in the dPOL Configure Output window or directly via the I^2C by writing into the CLS register. However, it is recommended to keep the temperature compensation enabled.

6.5.2.2. Undervoltage Protection

The undervoltage protection is only active during steady state operation of the dPOL to prevent nuisance tripping. If the output voltage decreases below the UV threshold and there is no OC fault, the UV fault signal is generated, the dPOL turns off, and the UV bit in the register ST is changed to 0. The output voltage is ramped down according to sequencing and tracking settings (regular turn-off).



6.5.2.3. Overtemperature Protection

Overtemperature protection is active whenever the dPOL is powered up. If temperature of the controller exceeds 120°C, the OT fault is generated, dPOL turns off, and the OT bit in the register ST is changed to 0. The output voltage is ramped down according to sequencing and tracking settings (regular turn-off).

If non-latching OTP is programmed, the dPOL will restart as soon as the temperature of the controller decreases below the Overtemperature Warning threshold of 110°C.

6.5.2.4. Tracking Protection

Tracking protection is active only when the output voltage is ramping up. The purpose of the protection is to ensure that the voltage differential between multiple rails being tracked does not exceed 250mV. This protection eliminates the need for external clamping diodes between different voltage rails which are frequently recommended by ASIC manufacturers.

When the tracking protection is enabled, the dPOL continuously compares actual value of the output voltage to its programmed value as defined by the output voltage and its rising slew rate. If absolute value of the difference exceeds 250mV, the tracking fault signal is generated, the dPOL turns off, and the TR bit in the register ST is changed to 0. Both high side and low side switches of the dPOL are turned off instantly (fast turn-off).

The tracking protection can be disabled, if it contradicts requirements of a particular system (for example turning into high capacitive load where rising slew rate is not important). It can be disabled in the dPOL Configure Fault window or directly via the I²C bus by writing into the PC1 register.

6.5.3. Faults and Margining

As noted earlier, UV and OV protection settings are a percentage of Vout. As Vout ramps between nominal, low or high margin values, UVP and OVP limits adjust accordingly. This is illustrated in Figure 28. The middle plot of Vo (Vout) level is the result of a Low Margining command. Note that Tracking is not re-enabled during changes to Vout from margining commands. It shuts off when PG is asserted.

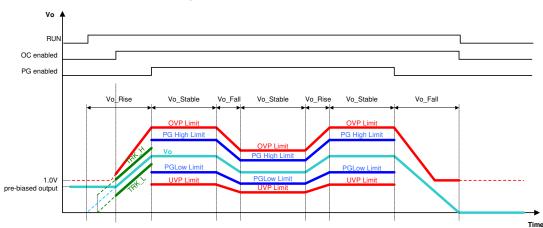


Figure 26. Protection Enable Conditions

6.5.4.Errors

The protection group includes only overvoltage protection:

6.5.4.1. Overvoltage Protection

The overvoltage protection is active whenever the output voltage of the dPOL exceeds the pre-bias voltage (if any). If the output voltage exceeds the overvoltage protection threshold, the overvoltage error signal is generated, the dPOL turns off, and the OV bit in the register ST is changed to 0. The high side switch is turned off instantly, and simultaneously the low side switch is turned on to ensure reliable protection of sensitive loads. The low side switch provides low impedance path to quickly dissipate energy stored in the output filter and achieve effective voltage limitation. The OV threshold can be programmed from 110% to 130% of the output voltage setpoint, but not lower than 0.5V. Also the OV threshold will always be at least 0.25V above the setpoint.



6.5.5. Fault and Error Latching

The user has the option of setting up any protection option as either latching/non-latching and propagating or non-propagating.

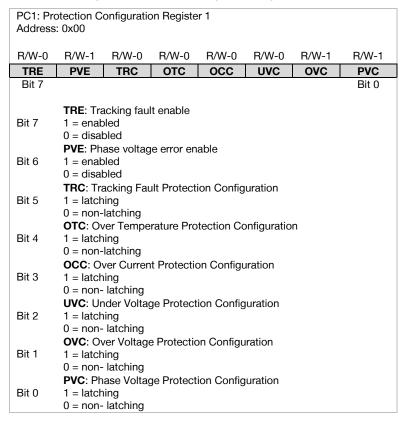
Propagation and Latching for each POL is set in the GUI (Figure 29 below) or directly via the I²C by writing into the PC1 register shown in Figure 30.

Fault Output Sequencing Controller Enable Latching Propagate Turn-Off Trigger Tracking Differential Critical 1 1 Sequenced Over-Temperature 1 Over-Current Critical 1 V Sequenced Under-Voltage 1 1 Emergency Over-Voltage

Figure 27. GUI dPOL Fault Propagation Option Window

If the non-latching protection is selected, a dPOL will attempt to restart every 130ms until the condition that triggered the protection is removed. When restarting, the output voltages follow tracking and sequencing settings. If the latching type is selected, a dPOL will turn off and stay off. The dPOL can be turned on after 130ms, if the condition that caused the fault is removed and the respective bit in the ST register was cleared, or the Turn On command was recycled, or the input voltage was recycled.

Figure 28. Protection Configuration Register PC1





6.5.6. Fault and Error Turn Off Control

In the GUI dPOL Fault dialog is a column of spin controls which set the Turn-Off style OT, UV and OV events. The choices are defined as:

Sequenced: Outputs shut down according to ramp down rate control settings. This is the method used when a dPOL is told to do a normal, controlled shut down.

Critical: Both high side and low side switches of the dPOL are turned off instantly.

Emergency: The high side switch is turned off instantly, and simultaneously the low side switch is turned on to ensure reliable protection of sensitive loads.

6.5.7. Fault and Error Status

Status of dPOL protection logic is stored in the dPOL's ST register shown in Figure 31. When Status monitoring is enabled for a group, the DPM will read this register and make the information available for uses such as GUI Monitor display.

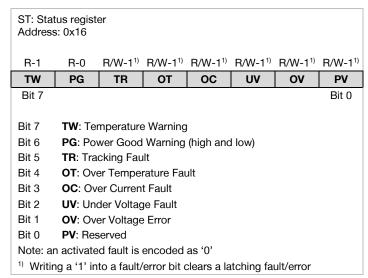


Figure 29. Protection Status Register ST

6.5.8. Fault and Error Propagation

The feature adds flexibility to the fault management scheme by giving users control over propagation of fault signals within and outside of the system. The propagation means that a fault in one dPOL can be programmed to turn off other dPOLs and devices in the system, even if they are not directly affected by the fault

6.5.8.1. Fault Propagation

When propagation is enabled, a faulty dPOL propagates declaration of that even through pulling its OK pin low. This signals to the DPM and any other dPOL connected to that signal, that the dPOL has a Fault or Error condition. A low OK line initiates turn-off of other dPOLs connected to the same OK line with the same turn-off behavior as the faulty dPOL. The turn-off type is encoded into the OK line when it transitions from high to low.

6.5.8.2. Grouping of dPOLs

Interconnecting OK lines between dPOLs and the DPM defines a Group. d-pwer dPOLs can be arranged in groups of up to 4, 8, 16 or 32 POLs (depending upon the DPM model used). For proper operation, membership in a group is set in the GUI in the **DPM / Configure / Devices** dialog, and implemented in hardware by connecting the OK pins of each POL in the group to the matching OK input on the DPM.

In order for a particular Fault or Error to propagate through the OK line, Propagation needs to be checked in the GUI **POL Configure / Fault** Management Window. This read in the dPOLs PC3 register shown in Figure 32.



Addr = 0x5e | ID = 65535 ZM7332 ✓ Device Configure Type Bus Voltages Devices Faults User Memory Turn-On Fault Propagation All correctly programmed Devices will start-up. Only Groups with no programming error will start-up System doesn't start if there is a programming error This setting affects the Group auto turn-on feature and also the Group/System I2C turn-on commands Changing this option requires the DPM to be power cycled after programming! Group Fault Propagation To On Error 000 0 0 0 0000 0 0 0 0 0 0 C 000 0 0 0 Interrupt Propagation

Figure 30. Protection Configuration Register PC3

Note that the turn-off type of the fault as it propagates through the DPM will remain unchanged. Propagation options for dPOLs can be read or set in the dPOL PC3 register shown in Figure 33. The turn-off type of the fault propagation through the DPM will remain unchanged.

6.5.9. Front End and Crowbar

As shown in the propagation dialog, if an error is propagated, the DPM can be configured to generate commands to turn off a front end (a DC-DC converter generating the intermediate bus voltage) or trigger crowbar protection to accelerate removal of the IBV voltage. (The two options are independent of inter-group propagation, and may require some external hardware to interface to the front end supply or crow-bar SCR device.)

PC3: Protection Configuration Register 3 Address: 0x02 U U R/W-1 R/W-1 R/W-1 R/W-1 R/W-1 R/W-1 **TRP** UVP OVP PVP Bit 7 Bit 0 Unimplemented: Read as '0' Bit 7:6 TRP: Tracking Protection Propagation Bit 5 0 = disabled1 = enabled **OTP**: Over Temperature Protection Propagation Bit 4 0 = disabled1 = enabled**OCP**: Over Current Protection Propagation Bit 3 0 = disabled1 = enabled**UVP**: Under Voltage Protection Propagation Bit 2 0 = disabled1 = enabled**OVP**: Over Voltage Protection Propagation Bit 1 0 = disabled1 = enabledBit 0 PVP: Reserved

Figure 31. DPM Configure Faults Window





6.5.10. Front End and Crowbar

If an error is propagated to at least the Group level, the DPM can also be configured to generate commands to turn off a front end (a DC-DC converter generating the intermediate bus voltage) and to trigger an optional crowbar protection to accelerate removal of the IBV voltage.

6.5.11. Propagation Examples

Understanding Fault and Error propagation is easier with the following examples.

The First example is of of non-propagation from a dPOL, as shown in Figure 34. An undervoltage error shuts down the Vo, but since propagation was not enabled, OK-A is not pulled down and Vo2 stays up.

Figure 32. No Group Fault Propagation

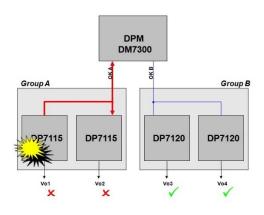


Figure 33. Turn-On into UVP on V3. The UV Fault Is Programmed To Be Non-Latching. Ch1 – Vo1, Ch2 – Vo2(Group A), Ch3 – Vo3 (Group B) Vo4 not shown.

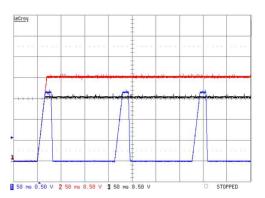


Figure 35 shows a scope capture an actual system when undervoltage error detection is set to not propagate.

In this example, the dPOL connected to scope Ch 1 encounters the undervoltage fault after turn-on. Because fault propagation is not enabled for this POL, it alone turns off and generates the UV fault signal. Because a UV fault triggers the sequenced turn-off, the dPOL meets its turn-off delay and falling slew rate settings during the turn-off process as shown in the trace for Ch1. Since the UV fault is programmed to be non-latching, the dPOL will attempt to restart every 130 ms, repeating the process described above until the condition causing the undervoltage is removed. The 130ms hiccup interval is guaranteed regardless of the turn-off delay setting.

The next example is intra-group propagation, the dPOL propagates its fault or error events. Here fault propagation between POLs is enabled.

In Figure 36 the dPOL powering output Vo1 again encounters an undervoltage error. It pulls its OK line low. Since the dPOL powering output Vo2 (Ch3 in the picture) belongs to the same group (A in this case), pulling down OK-A tells that dPOL to execute a regular turn-off.

Figure 34 Intra Group Fault Propagation

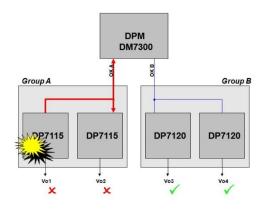
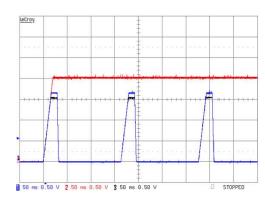


Figure 35. Turn-On into UVP on V3. The UV Fault Is Programmed To Be Non-Latching and Propagate From Group C to Group A. Ch1 – V3 (Group C), Ch2 – V2, Ch3 – V1 (Group A)





Since both Vo1 and Vo2 have the same delay and slew rate settings they will continue to turn off and on synchronously every 130ms as shown in Figure 37 until the condition causing the undervoltage is removed.

Note that the dPOL powering the output Vo2 (Ch3) actually reaches its voltage set point before the error in Vo1 is detected.

The turn-off type of a POL fault/error as propagated by the faulty dPOL via the OK line is propagated through the DPM to other dPOLs connected to other Groups through its connection to their OK line or lines.

This behavior assures that all dPOLs configured to be affected through Group linkages will switch off with the same turn-off type.

6.5.12. Protection Summary

A summary of protection support, their parameters and features are shown in Table 2.

LOW SIDE CODE NAME **TYPE** WHEN ACTIVE **TURN OFF PROPAGATION DISABLE SWITCH** Temperature TW N/A Status Bit Warning Whenever V_{IN} is applied No No Warning PG During steady state PG Power Good Warning No N/A No TR Fault During ramp up Fast Off Critical Yes Tracking Sequenced or OT Overtemperature Fault Whenever V_{IN} is applied Regular Off No Critical OC Overcurrent Fault When V_{OUT} exceeds prebias Fast Off Critical No Sequenced or UV Undervoltage Fault During steady state Regular Off No Critical Critical or OV Overvoltage When Vout exceeds prebias Fast Error On No Emergency

Table 2. Summary of Protection Parameters and Features

6.6. OK FAULT AND ERROR CODING

d-pwer® dPOLs have an additional functionality added to the OK line signal. The OK line is used to propagate and receive information from other devices in the power system belonging to the same group as to the kind of turn-off procedure a device has initiated because of a fault

Figure 38 shows the three types of OK encoding. The bubbles show when the SD and OK line logic levels are sampled by dPOL and the DPM logic.

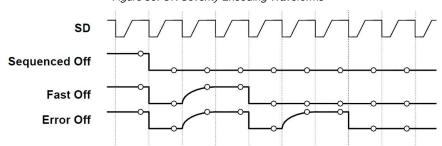


Figure 36. OK Severity Encoding Waveforms

Note that the OK line state changes are always executed by dPOLs at the negative edge of the SD line.

The chart shows shut down response types as the user can select the kind of response desired for each type of Fault or Error (within the limits of choice provided for each type of Fault or Error). All dPOL devices in the same Group are expected to trigger the same turn-off procedure in order to maintain overall tracking of output voltages in the system. And when fault propagation is set to go from one group to another, the encoding is passed along un-changed.



6.7. SWITCHING AND COMPENSATION

d-pwer® dPOLs utilize the digital PWM controller. The controller enables users to program most of the performance parameters, such as switching frequency, PWM duty cycle and limiting, interleave, and feedback loop compensation.

6.7.1.Switching Frequency

The switching frequency of the DP8140G can be programmed only to 500KHz in the GUI PWM Controller window shown in Figure 39 or directly via the I²C bus by writing into the INT register shown in Figure 40.

Each dPOL is equipped with a PLL that locks to the 500 KHzSD signal which is generated by the DPM. This sets up for switching actions to be synchronous to the falling edge of SD by all dPOLs, which are thereby kept coordinated to each other.

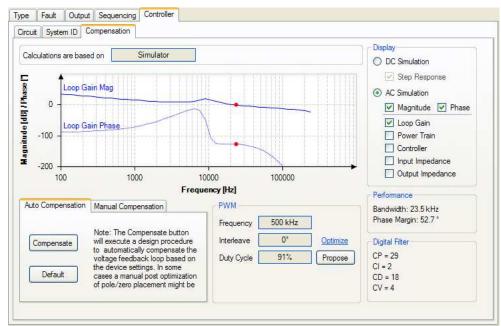


Figure 37. PWM Controller Window

In some applications, switching at higher frequencies is desirable even though efficiency is lower, because it allows for better transient response or lower application system noise.

6.7.2.Interleave Selection

Within the same PWM dialog is the switching Interleave control. Interleave is defined as a phase delay between the synchronizing slope of the master clock on the SD pin and the start of each dPOL PWM cycle. This parameter can be programmed in the dPOL Controller Configure Compensation window or directly via the I²C bus by writing into the INT register in 22.5° steps.

